

RQ6E050AT

Pch -30V -5A Power MOSFET

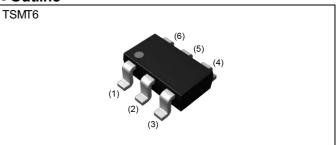
V _{DSS}	-30V
R _{DS(on)} (Max.)	27mΩ
Ι _D	±5.0A
PD	1.25W

Features

- 1) Low on resistance.
- 2) Small Surface Mount Package (TSMT6).
- 3) Pb-free lead plating ; RoHS compliant

Datasheet





Inner circuit

 (1) Drain (2) Drain (3) Gate (4) Source (5) Drain (6) Drain 		
*1 Body Diode	(1) (2) (3)	

Packaging specifications

	Packing	Embossed Tape
	Reel size (mm)	180
Туре	Tape width (mm)	8
•••	Basic ordering unit (pcs)	3000
	Taping code	TCR
	Marking	VB

Application

Switching

• Absolute maximum ratings ($T_a = 25^{\circ}C$)

Parameter	Symbol	Value	Unit
Drain - Source voltage	V _{DSS}	-30	V
Continuous drain current	۱ _D *1	±5.0	А
Pulsed drain current	I _{D,pulse} *2	±18	А
Gate - Source voltage	V _{GSS}	±20	V
Avalanche energy, single pulse	E _{AS} *3	18.2	mJ
Avalanche current	I _{AS} *3	-5.0	А
Power dissipation	P _D ^{*4}	1.25	W
Junction temperature	T _j	150	°C
Range of storage temperature	T _{stg}	-55 to +150	C°

•Thermal resistance

Parameter	Symbol	Values			Linit
Falameter	Symbol	Min.	Тур.	Max.	Unit
Thermal resistance, junction - ambient	R _{thJA} *4	-	100	-	°C/W

•Electrical characteristics (T_a = 25°C)

Deremeter	er Symbol Conditions			Values		Unit	
Parameter	Symbol	Conditions		Тур.	Max.	Unit	
Drain - Source breakdown voltage	V _{(BR)DSS}	_{BR)DSS} $V_{GS} = 0V, I_D = -1mA$		-	-	V	
Breakdown voltage temperature coefficient	$\frac{\Delta V_{(BR)DSS}}{\Delta T_j}$	$\frac{\Delta V_{(BR)DSS}}{\Delta T_{j}} I_{D} = -1 mA$ referenced to 25°C		-22	-	mV/°C	
Zero gate voltage drain current	I _{DSS}	$V_{\rm DSS}$ $V_{\rm DS}$ = -30V, $V_{\rm GS}$ = 0V		-	-1	μA	
Gate - Source leakage current	I _{GSS}	$_{GSS}$ V _{GS} = ±20V, V _{DS} = 0V		-	±100	nA	
Gate threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = -1mA$	-1.0	-	-2.5	V	
Gate threshold voltage temperature coefficient	$\frac{\Delta V_{GS(th)}}{\Delta T_j}$			2.9	-	mV/°C	
Static drain - source	D *5	V _{GS} = -10V, I _D = -5A	-	21	27		
on - state resistance	$R_{DS(on)}^{*5}$	V _{GS} = -4.5V, I _D = -5A	-	29	38	mΩ	
Transconductance	${\sf g_{fs}}^{*5}$	V _{DS} = -5V, I _D = -5A	5.0	-	-	S	

*1 Limited only by maximum temperature allowed.

*2 Pw \leq 10µs, Duty cycle \leq 1%

*3 L \simeq 1mH, V_{DD} = -15V, R_G = 25 Ω , STARTING T_{ch} = 25°C Fig.3-1,3-2

*4 Mounted on a ceramic boad (30×30×0.8mm)

*5 Pulsed



•Electrical characteristics (T_a = 25°C)

Deremeter	Cumphed	Conditions	Values			Unit	
Parameter	Symbol Conditions		Min.	Тур.	Max.	Unit	
Input capacitance	C _{iss}	V _{GS} = 0V	-	940	-		
Output capacitance	C _{oss}	V _{DS} = -15V	-	170	-	pF	
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	130	-		
Turn - on delay time	t _{d(on)} *5	$V_{DD} \simeq -15V, V_{GS} = -10V$	-	9.6	-		
Rise time	t _r *5	I _D = -2.5A	-	16	-		
Turn - off delay time	t _{d(off)} *5	R _L = 6.0Ω	-	55	-	ns	
Fall time	t _f *5	R _G = 10Ω	-	22	-		

• Gate charge characteristics ($T_a = 25^{\circ}C$)

Parameter	Symbol	Conditi	Conditions		Values		
	Symbol	bol Conditions -		Min.	Тур.	Max.	Unit
Total gata abarga	∩ *5		V _{GS} = -10V	-	20.8	-	
Total gate charge	y g	Q _g *5 V _{DD} ≃ -15V		-	10.4	-	-0
Gate - Source charge	Q_{gs}^{*5}	I _D = -5A	V _{GS} = -4.5V	-	3.2	-	nC
Gate - Drain charge	Q_{gd}^{*5}			-	4.0	-	

•Body diode electirical characteristics (Source-Drain) (T_a = 25°C)

Parameter	Symbol	Conditions	Values			Unit
	er Symbol Conditions		Min.	Тур.	Max.	Unit
Body diode continuous forward current	۱ _S *1	T - 25°0	-	-	-1.0	•
Body diode pulse current	I _{SP} *2	$T_a = 25^{\circ}C$	-	-	-18	A
Forward voltage	V _{SD} *5	V _{GS} = 0V, I _S = -1.0A	-	-	-1.2	V

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• Electrical characteristic curves

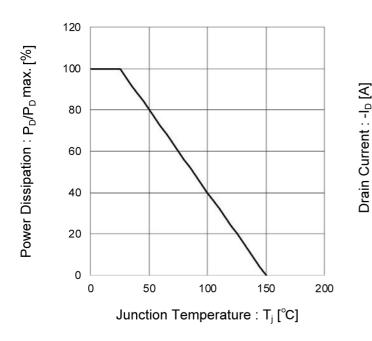
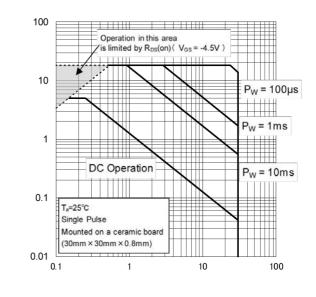


Fig.1 Power Dissipation Derating Curve

Fig.2 Maximum Safe Operating Area



Drain - Source Voltage : -V_{DS} [V]

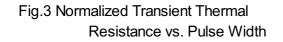
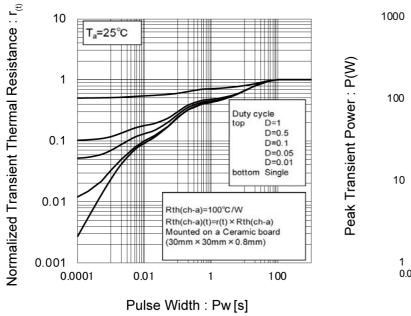
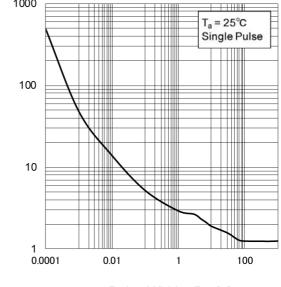


Fig.4 Single Pulse Maximum Power dissipation





Pulse Width : Pw [s]



Drain Current : -I_D [A]

• Electrical characteristic curves

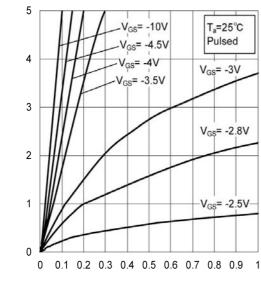


Fig.5 Typical Output Characteristics(I)

Drain - Source Voltage : -V $_{DS}$ [V]

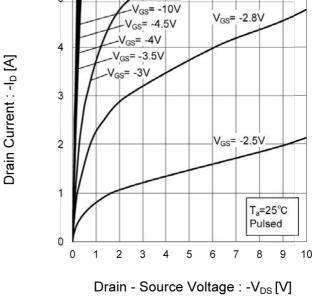
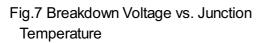
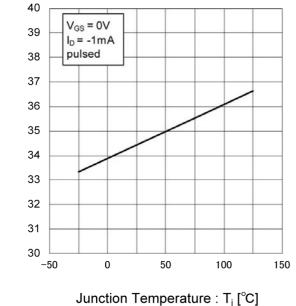


Fig.6 Typical Output Characteristics(II)

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Drain-Source Breakdown Voltage : -V_{(BR)DSS} [V]











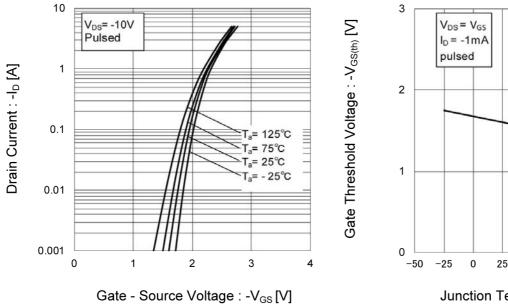


Fig.9 Gate Threshold Voltage vs. Junction Temperature

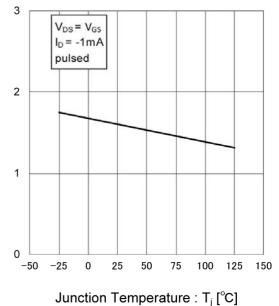
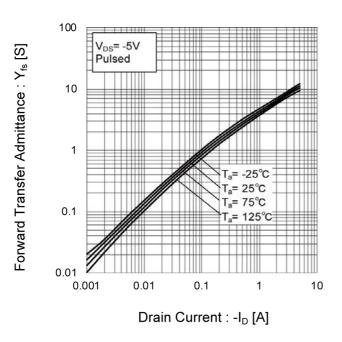


Fig.10 Transconductance vs. Drain Current





• Electrical characteristic curves

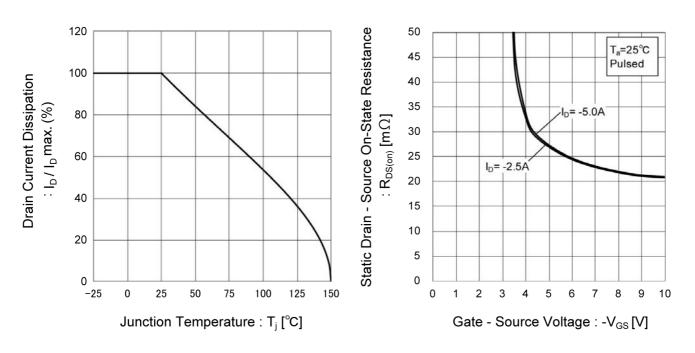


Fig.11 Drain Current Derating Curve

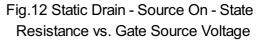


Fig.13 Static Drain - Source On - State Resistance vs. Junction Temperature

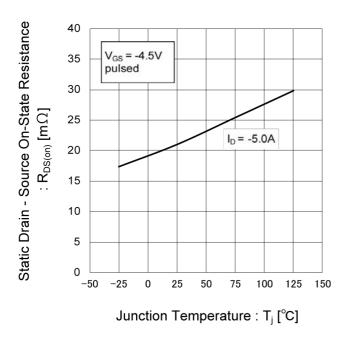




Fig.15 Static Drain - Source On - State

• Electrical characteristic curves

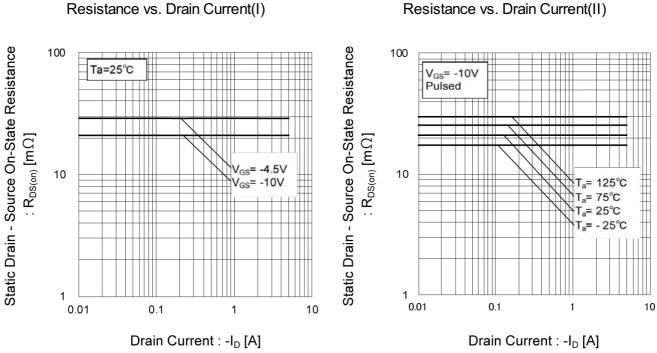
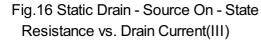
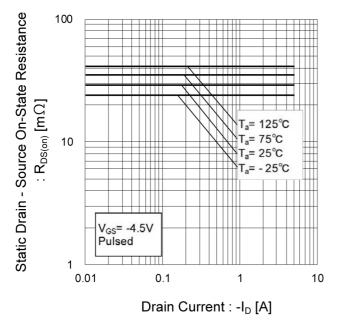


Fig.14 Static Drain - Source On - State Resistance vs. Drain Current(I)







• Electrical characteristic curves

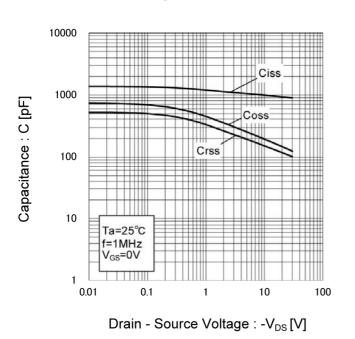


Fig.17 Typical Capacitance vs. Drain -Source Voltage

Fig.18 Switching Characteristics

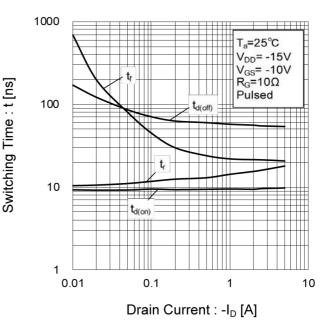


Fig.19 Dynamic Input Characteristics

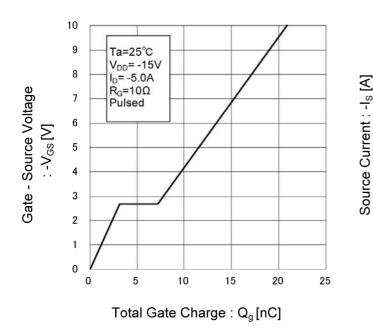
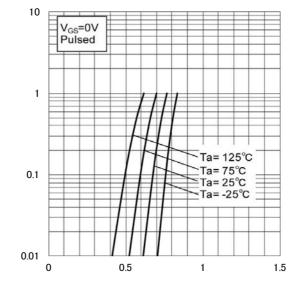


Fig.20 Source Current vs. Source Drain Voltage



Source - Drain Voltage : -V_{SD} [V]



Measurement circuits



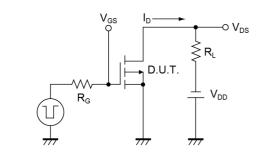


Fig.2-1 Gate Charge Measurement Circuit

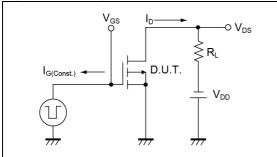


Fig.3-1 AVALANCHE MEASUREMENT CIRCUIT

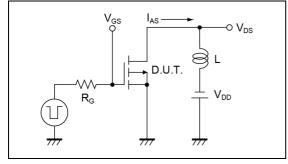


Fig.1-2 Switching Waveforms

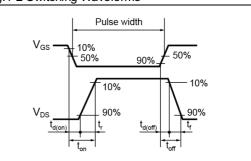


Fig.2-2 Gate Charge Waveform

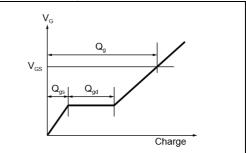
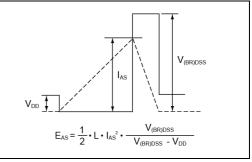


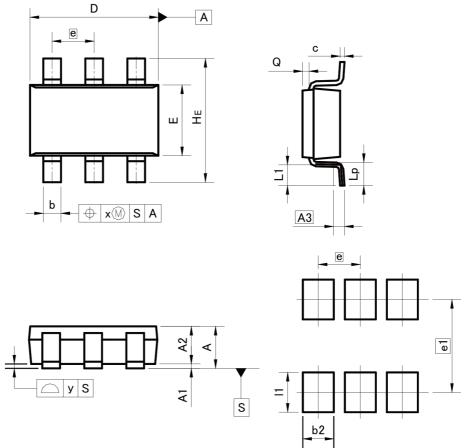
Fig.3-2 AVALANCHE WAVEFORM





Dimensions

TSMT6



Pattern of terminal position areas [Not a recommended pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
	MIN	MAX	MIN	MAX
A	-	1.00	(-)	0.039
A1	0.00	0.10	0.000	0.004
A2	0.75	0.95	0.030	0.037
A3	0.	25	0.0	10
b	0.35	0.50	0.014	0.020
С	0.10	0.26	0.004	0.010
D	2.80	3.00	0.110	0.118
E	1.50	1.80	0.059	0.071
е	0.	95	0.0	37
HE	2.60	3.00	0.102	0.118
L1	0.30	0.60	0.012	0.024
Lp	0.40	0.70	0.016	0.028
Q	0.05	0.25	0.002	0.010
x	<u>84</u> 8	0.20	-	0.008
у	-	0.10	3 — 7	0.004
	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
b2		0.70	(E)	0.028
e1	2.	10	0.0	83
11	-	0.90	2 — 9	0.035

Dimension in mm/inches





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	CLASSⅣ	CLASSII	CLASSⅢ	CLASSI

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 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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